# Si4114DY

RoHS

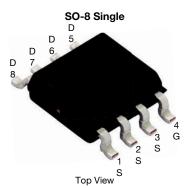
COMPLIANT

HALOGEN

FREE

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**Vishay Siliconix** 



PRODUCT SUMMARY					
V <sub>DS</sub> (V)	20				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS}$ = 10 V	0.006				
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_GS$ = 4.5 V	0.007				
Q <sub>g</sub> typ. (nC)	27.5				
I <sub>D</sub> (A) <sup>a, e</sup>	20				
Configuration	Single				

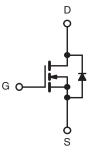
#### **FEATURES**

N-Channel 20 V (D-S) MOSFET

- TrenchFET<sup>®</sup> power MOSFET
- 100 %  $\rm R_g$  and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **APPLICATIONS**

- · Low side MOSFET for synchronous buck
  - Game machine
- PC



N-Channel MOSFET

ORDERING INFORMATION			
Package	SO-8		
Lead (Pb)-free	Si4114DY-T1-E3		
Lead (Pb)-free and halogen-free	Si4114DY-T1-GE3		

PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V <sub>DS</sub>	20	V	
Gate-source voltage		V <sub>GS</sub>	± 16	V	
	T <sub>C</sub> = 25 °C		20 <sup>e</sup>		
Continuous drain surrent (T 150 °C)	T <sub>C</sub> = 70 °C		18.2		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	15.2 <sup>b, c</sup>		
	T <sub>A</sub> = 70 °C		12.1 <sup>b, c</sup>	•	
Pulsed drain current		I <sub>DM</sub>	50	A	
Continuous source-drain diode current	T <sub>C</sub> = 25 °C	- I <sub>S</sub>	5.1		
	T <sub>A</sub> = 25 °C		2.2 <sup>b, c</sup>		
Single pulse avalanche current		I <sub>AS</sub>	30		
Avalanche energy	L = 0.1 mH	E <sub>AS</sub>	45	mJ	
Maximum power dissipation	T <sub>C</sub> = 25 °C		5.7		
	T <sub>C</sub> = 70 °C		3.6	10/	
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5 <sup>b, c</sup>	W	
	T <sub>A</sub> = 70 °C	1	1.6 <sup>b, c</sup>		
Operating junction and storage temperature range		TJ, Tstg	-55 to +150	°C	

#### THERMAL RESISTANCE RATINGS

PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT	
Maximum junction-to-ambient b, d	t ≤ 10 s	R <sub>thJA</sub>	39	50	°C M/	
Maximum junction-to-foot (drain)	Steady state	R <sub>thJF</sub>	18	22	°C/W	

#### Notes

a. Based on  $T_C = 25 \ ^{\circ}C$ 

b. Surface mounted on 1" x 1" FR4 board

c. t = 10 s

d. Maximum under steady state conditions is 85 °C/W

e. Package limited

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## Si4114DY

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PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static	•				•		
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = 250 \mu A$	20	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	L 050 ··· A	-	19	-		
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = 250 μA	-	-5.3	-	mV/°C	
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1	-	2.1	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 16 V$	-	-	± 100	nA	
Zava anto valtaga duain ovument	1	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}$	-	-	1	μΑ	
Zero gate voltage drain current	IDSS	$V_{DS} = 20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 ^{\circ}\text{C}$	-	-	10		
On-state drain current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	30	-	-	А	
Drain actures on state registeres a	D	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	0.0049	0.0060	Ω	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 7 \text{ A}$	-	0.0056	0.0070		
Forward transconductance <sup>a</sup>	g <sub>fs</sub>	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$	-	55	-	S	
Dynamic <sup>b</sup>					•	•	
Input capacitance	C <sub>iss</sub>		-	3700	-	pF	
Output capacitance	C <sub>oss</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	-	745	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	315	-		
Total and a share a	Q <sub>g</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 10 \text{ A}$	-	62	95	nC	
Total gate charge			-	27.5	42		
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$	-	8	-		
Gate-drain charge	Q <sub>gd</sub>		-	6	-		
Gate resistance	R <sub>g</sub>	f = 1 MHz	0.15	0.7	1.4	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	30	55	1	
Rise time	t <sub>r</sub>	$V_{DD}$ = 10 V, $R_L$ = 2 $\Omega$	-	13	25		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 5$ A, $V_{GEN}$ = 4.5 V, $R_g$ = 1 $\Omega$	-	60	100		
Fall time	t <sub>f</sub>		-	30	55		
Turn-on delay time	t <sub>d(on)</sub>		-	13	25	ns	
Rise time	t <sub>r</sub>	$V_{DD} = 10 V, R_1 = 2 \Omega$	-	9	18	1	
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong 5$ A, $V_{GEN}$ = 10 V, $R_g$ = 1 $\Omega$	-	38	65		
Fall time	t <sub>f</sub>		-	8	16		
Drain-Source Body Diode Characteris	tics				•		
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	5.1	•	
Pulse diode forward current <sup>a</sup>	I <sub>SM</sub>		-	-	50	A	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = 2 A	-	0.71	1.1	V	
Body diode reverse recovery time	t <sub>rr</sub>	-	-	26	50	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = 10 A, di/dt = 100 A/μs,	-	16	30	nC	
Reverse recovery fall time	t <sub>a</sub>	$T_J = 25 \text{ °C}$	-	13	-		
Reverse recovery rise time	t <sub>b</sub>		-	13	-	ns	

Notes

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %

b. Guaranteed by design, not subject to production testing

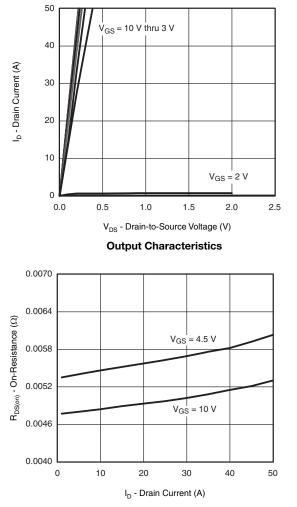
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2

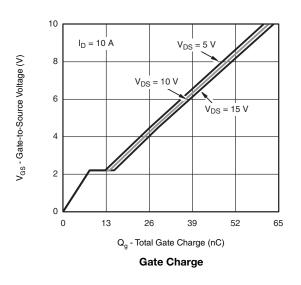
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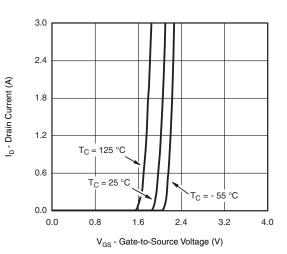


### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

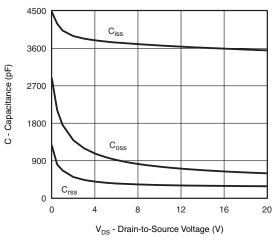


**On-Resistance vs. Drain Current and Gate Voltage** 

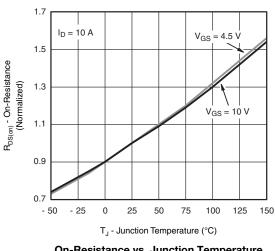




**Transfer Characteristics** 







**On-Resistance vs. Junction Temperature** 

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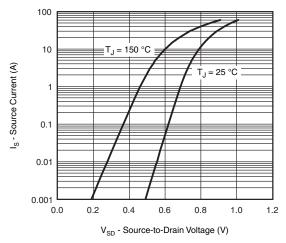
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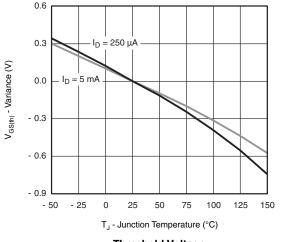
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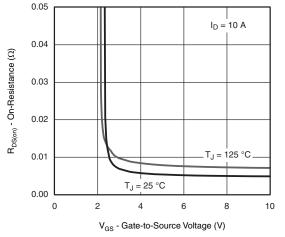
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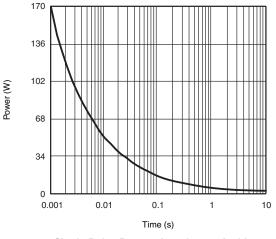
Source-Drain Diode Forward Voltage



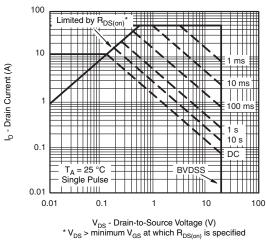




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



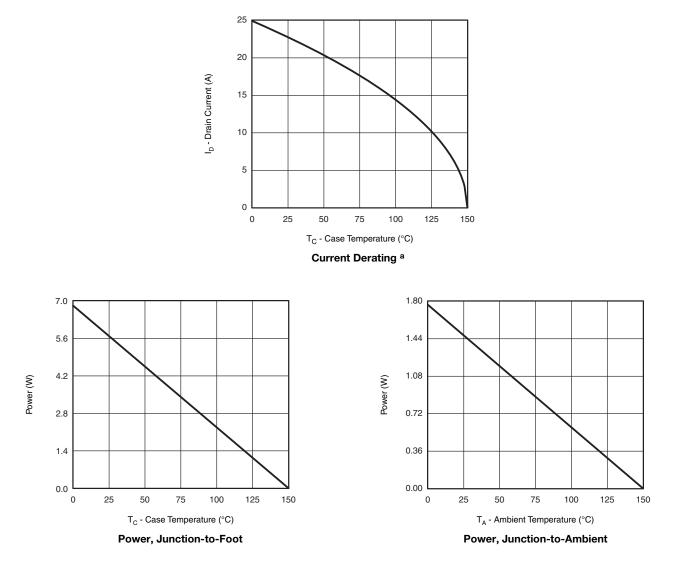
Safe Operating Area, Junction-to-Ambient

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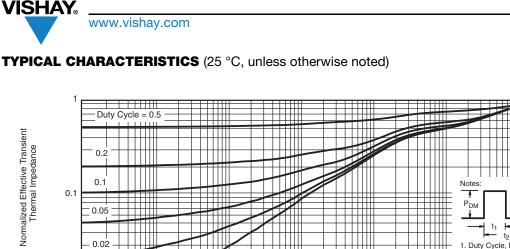


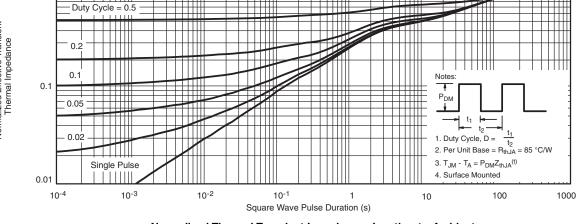
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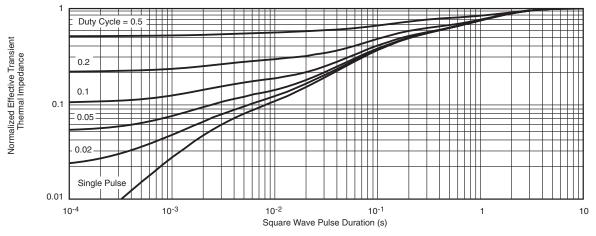
#### Notes

a. The power dissipation P<sub>D</sub> is based on T<sub>J</sub> max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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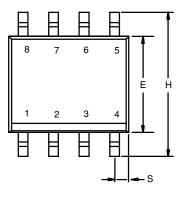


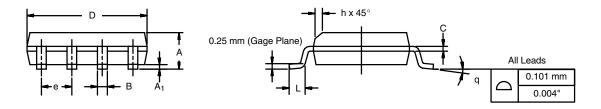
# Package Information

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## SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012





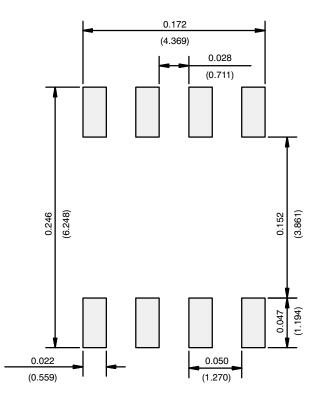
	MILLIM	IETERS	INC	HES	
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

# **Application Note 826**

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**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

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